30V N-Channel PowerTrench[®] MOSFET

General Description

This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low RDS(ON) and fast switching speed.

Applications

- DC/DC converter
- Motor drives

G S TO-252

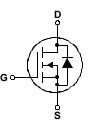


• 21 A, 30 V $R_{DS(ON)} = 35 \text{ m}\Omega @ V_{GS} = 10 \text{ V}$ $R_{DS(ON)} = 50 \text{ m}\Omega @ V_{GS} = 4.5 \text{ V}$

- Low gate charge (5nC typical)
- Fast switching

.

+ High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$



Absolute Maximum Ratings TA=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		30	V
V _{GSS}	Gate-Source Voltage		±20	V
l _D	Drain Current – Continuous	(Note 3)	21	A
	- Pulsed	(Note 1a)	100	
PD	Power Dissipation	(Note 1)	28	W
		(Note 1a)	3.2	
		(Note 1b)	1.3	
T_J, T_{STG}	Operating and Storage Junction Temper	ature Range	-55 to +175	°C

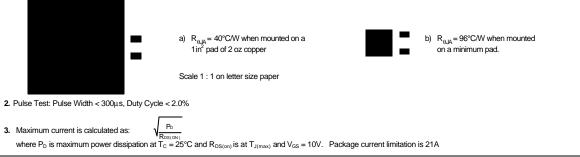
R _{0JC}	Thermal Resistance, Junction-to-Case	(Note 1)	4.5	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	40	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1b)	96	°C/W

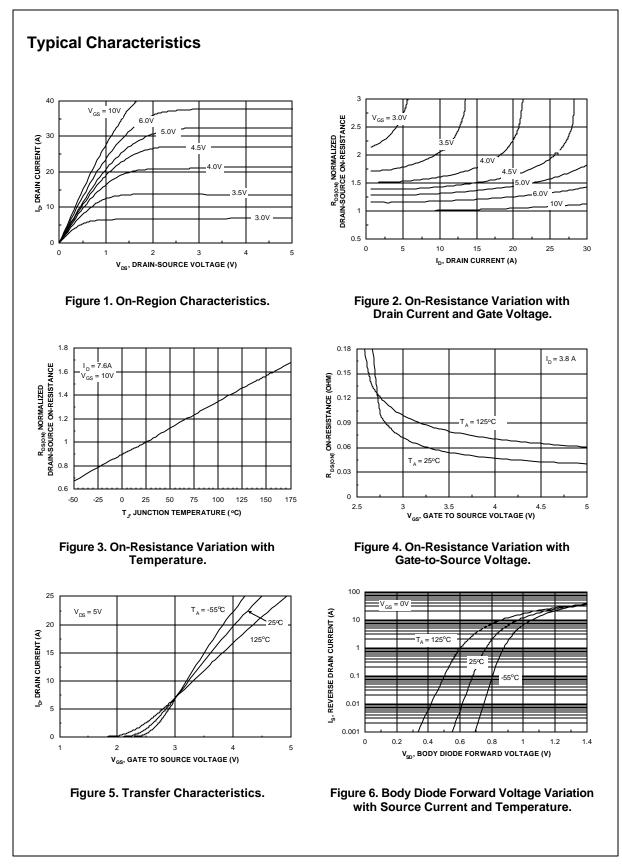
Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape width	Quantity
FDD6630A	FDD6630A	13"	16mm	2500 units
			•	

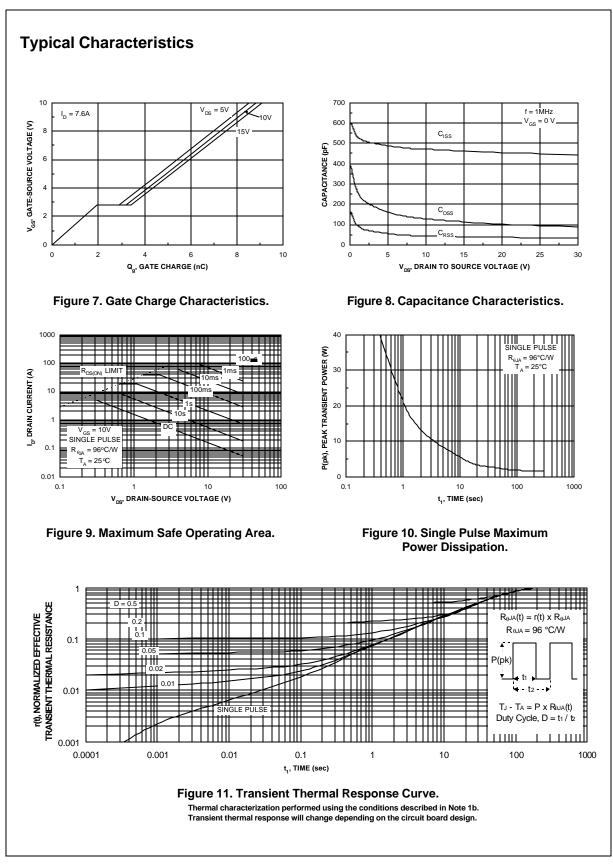
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Drain-So	Parameter	Test Conditions	Min	Тур	Max	Units
	urce Avalanche Ratings (Note	2)				
W _{DSS}	Drain-Source Avalanche Energy	Single Pulse, $V_{DD} = 15 V$			55	mJ
AR	Drain-Source Avalanche Current				7.6	Α
Off Chara	acteristics	•				
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 V, I_D = 250 \mu A$	30			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, Referenced to 25°C		23		mV/⁰C
DSS	Zero Gate Voltage Drain Current	$V_{DS} = 24 \text{ V}, \qquad V_{GS} = 0 \text{ V}$			1	μA
GSSF	Gate-Body Leakage, Forward	$V_{GS} = 20 \text{ V}, \qquad V_{DS} = 0 \text{ V}$			100	nA
GSSR	Gate-Body Leakage, Reverse	$V_{GS} = -20 \text{ V}, V_{DS} = 0 \text{ V}$			-100	nA
On Chara	Acteristics (Note 2)	•				
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1	1.7	3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \mu\text{A}$, Referenced to 25°C		-4		mV/°C
R _{DS(on)}	Static Drain-Source	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 7.6 \text{ A}$		28	35	mΩ
	On-Resistance	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 6.3 \text{ A}$		40 44	50 58	
D(on)	On–State Drain Current	$V_{GS} = 10 \text{ V}, I_D = 7.6 \text{ A}, T_J = 125^{\circ}\text{C}$ $V_{GS} = 10 \text{ V}, V_{DS} = 5 \text{ V}$	20	-++	50	А
g _{FS}	Forward Transconductance	$V_{\rm DS} = 5 \text{ V}, \qquad I_{\rm D} = 7.6 \text{ A}$		13		S
	Characteristics					
C _{iss}	Input Capacitance	$V_{DS} = 15 V$, $V_{GS} = 0 V$,		462		pF
Coss	Output Capacitance	f = 1.0 MHz		113		pF
Crss	Reverse Transfer Capacitance			40		pF
Switching	g Characteristics (Note 2)	1				
t _{d(on)}	Turn–On Delay Time	$V_{DD} = 15 V$, $I_{D} = 1 A$,		5	11	ns
t _r	Turn–On Rise Time	$V_{GS} = 10 \text{ V}, \qquad R_{GEN} = 6 \Omega$		8	17	ns
t _{d(off)}	Turn–Off Delay Time			17	28	ns
L()	Turn–Off Fall Time			13	24	ns
Qg	Total Gate Charge	$V_{DS} = 15 V$, $I_D = 7.6 A$,		5	7	nC
Q _{gs}	Gate–Source Charge	$V_{GS} = 5 V$		2		nC
Q _{gd}	Gate–Drain Charge			1.4		nC
Drain-So	ource Diode Characteristics	and Maximum Ratings		L	L	L
	Maximum Continuous Drain–Source				2.7	Α
s	Drain–Source Diode Forward	$V_{GS} = 0 V$, $I_S = 2.7 A$ (Note 2)		0.8	1.2	V





FDD6630A Rev. D1



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